

RS3L110AT

Pch -60V -11A Power MOSFET

V _{DSS}	-60V
R _{DS(on)} (Max.)	12.8mΩ
I _D	±11A
P_D	2.0W

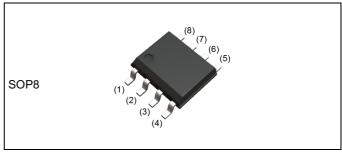
● Features

- 1) Low on resistance
- 2) Small Surface Mount Package (SOP8)
- 3) Pb-free plating; RoHS compliant

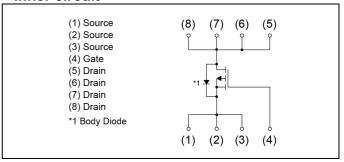
Application

Switching

Outline



•Inner circuit



Packaging specifications

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	Packing	Embossed Tape
	Reel size (mm)	330
Туре	Tape width (mm)	12
	Quantity (pcs)	2500
	Taping code	TB1
	Marking	RS3L110AT

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	-60	V
Continuous drain current	I _D	±11	Α
Pulsed drain current	I _{DP} *1	±44	Α
Gate - Source voltage	V _{GSS}	±20	V
Avalanche current, single pulse	I _{AS} *2	-11	Α
Avalanche energy, single pulse	E _{AS} *2	9	mJ
Down dissinction	P _D *3	2.0	W
Power dissipation	P _D *4	1.4	W
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

●Thermal resistance

Doramatar	Symbol	Values			1.1:4
Parameter		Min.	Тур.	Max.	Unit
Thermal registance innetion, ambient	R _{thJA} *3	-	-	62.5	°C/W
Thermal resistance, junction - ambient	R _{thJA} *4	-	-	89.2	°C/W

● Electrical characteristics (T_a = 25°C)

Davamatav	Cymah ol	Conditions	Values			Unit
Parameter	Symbol	Symbol Conditions M		Тур.	Max.	Offic
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V$, $I_D = -1mA$	-60	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I _D = -1mA referenced to 25°C	-	-22	-	mV/°C
Zero gate voltage drain current	I _{DSS}	V _{DS} = -60V, V _{GS} = 0V	-	-	-1	μA
Gate - Source leakage current	I _{GSS}	I_{GSS} $V_{GS} = \pm 20V$, $V_{DS} = 0V$		-	±100	nA
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -1mA$	-1.0	-	-2.5	V
Gate threshold voltage temperature coefficient	$\frac{\DeltaV_{GS(th)}}{\DeltaT_j}$	I _D = -1mA referenced to 25°C	-	3.7	-	mV/°C
Static drain - source	D *5	V _{GS} = -10V, I _D = -11A	-	10.1	12.8	mO.
on - state resistance	R _{DS(on)} *5	V _{GS} = -4.5V, I _D = -11A	-	11.2	14.3	mΩ
Gate resistance	R _G	f = 1MHz, open drain		3.8	-	Ω
Forward Transfer Admittance	Y _{fs} *5	V _{DS} = -5V, I _D = -11A	22	-	-	S

^{*1} Pw ≤ 10µs, Duty cycle ≤ 1%

^{*2} L \simeq 0.1mH, V_{DD} = -30V, R_G = 25 Ω , Starting T_j = 25 $^{\circ}$ C Fig.3-1,3-2

^{*3} Mounted on a ceramic board (30×30×0.8mm)

^{*4} Mounted on a Cu board (40×40×0.8mm)

^{*5} Pulsed

● Electrical characteristics (T_a = 25°C)

Dorameter	Cumbal	Conditions		Unit		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	6300	-	
Output capacitance	C _{oss}	V _{DS} = -30V	-	425	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	1	320	1	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq -30V, V_{GS} = -10V$	1	22	1	
Rise time	t _r *5	I _D = -5.5A	-	66	-	
Turn - off delay time	t _{d(off)} *5	$R_L \simeq 5.4\Omega$	-	315	-	ns
Fall time	t _f *5	$R_G = 10\Omega$	-	205	-	

● Gate charge characteristics (T_a = 25°C)

	\ a	,					
Parameter	Cymab al	Conditions		Values			l limit
raiametei	Symbol			Min.	Тур.	Max.	Unit
Total gate charge	Q _g *5	*5	V _{GS} = -10V	-	115.0	-	
Total gate charge		\mathbf{Q}_{g}	V _{DD} ≃ - 30V		-	55.0	-
Gate - Source charge	Q _{gs} *5	I _D = -11A	V _{GS} = -4.5V	-	19.0	-	nC
Gate - Drain charge	Q _{gd} *5			-	15.8	-	

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Darameter	Cumbal	Conditions		Unit		
Parameter	Symbol	Symbol Conditions		Тур.	Max.	Offic
Continuous forward current	I _S	T = 25°C	-	-	-1.67	Α
Pulse forward current	I _{SP} *1	T _a = 25°C	-	-	-44	Α
Forward voltage	V _{SD} *5	V _{GS} = 0V, I _S = -1.67A	-	-	-1.2	V
Reverse recovery time	t _{rr} *5	I _S = -11A, V _{GS} =0V	-	37	-	ns
Reverse recovery charge	Q _{rr} *5	di/dt = 100A/μs	-	34	-	nC

3/11

Fig.1 Power Dissipation Derating Curve

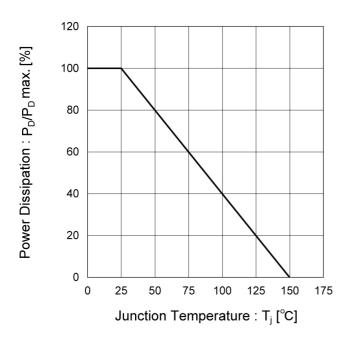
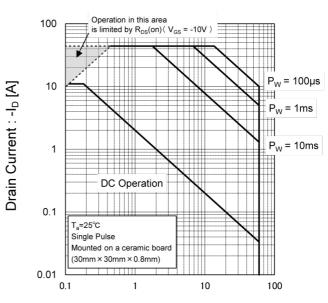


Fig.2 Maximum Safe Operating Area



Drain - Source Voltage : -V_{DS} [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

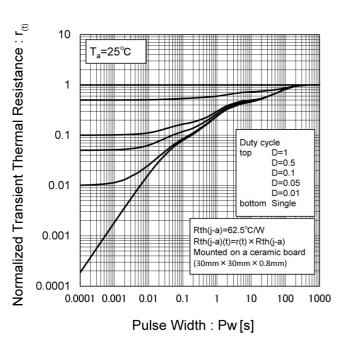


Fig.4 Single Pulse Maximum Power Dissipation

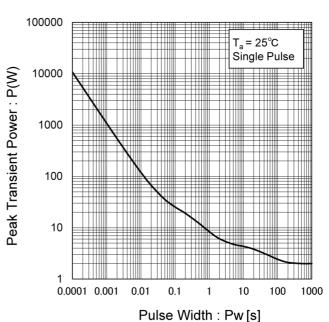


Fig.5 Typical Output Characteristics(I)

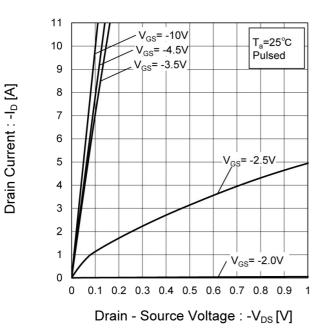
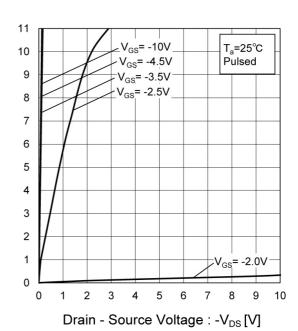


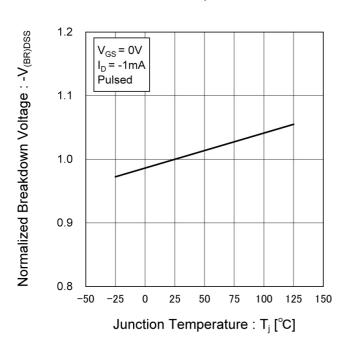
Fig.6 Typical Output Characteristics(II)



Drain Current : -I_D [A]

Fig.7 Breakdown Voltage vs.

Junction Temperature



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Fig.8 Typical Transfer Characteristics

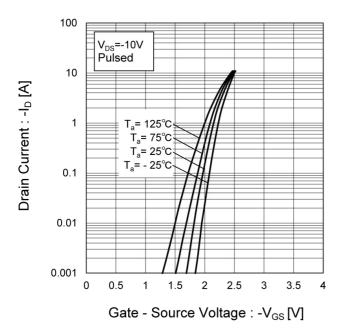


Fig.9 Gate Threshold Voltage vs.
Junction Temperature

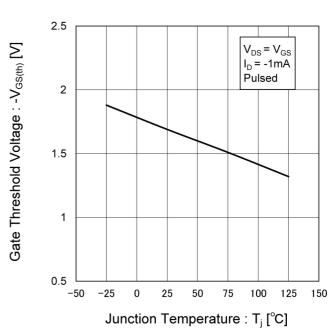


Fig.10 Forward Transfer Admittance vs.
Drain Current

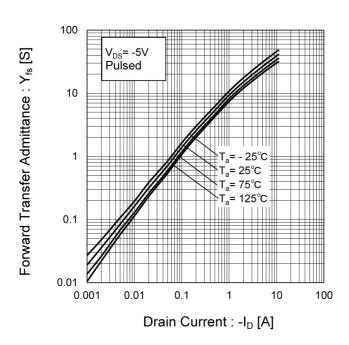


Fig.11 Drain Current Derating Curve

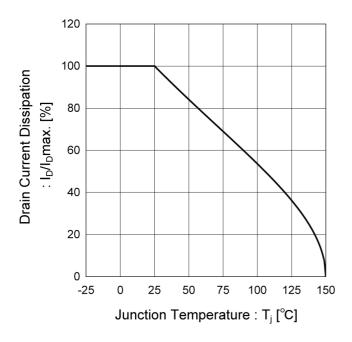


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

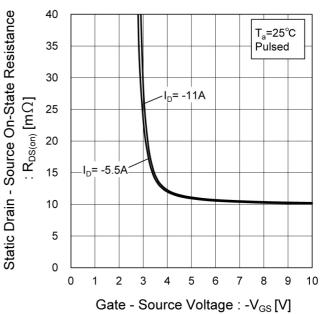


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

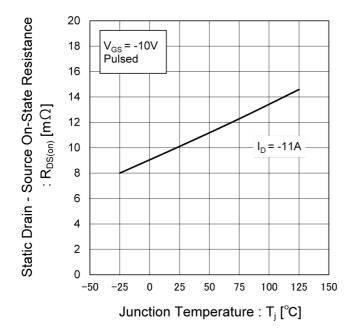


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

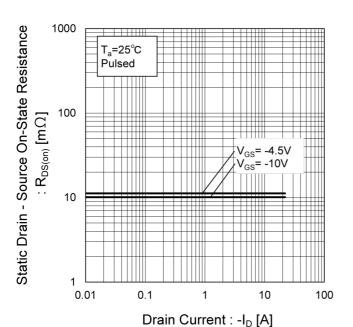


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

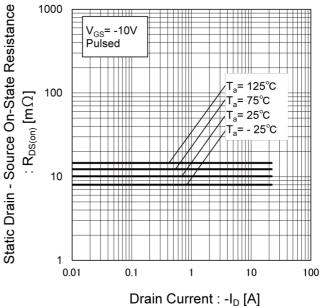


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

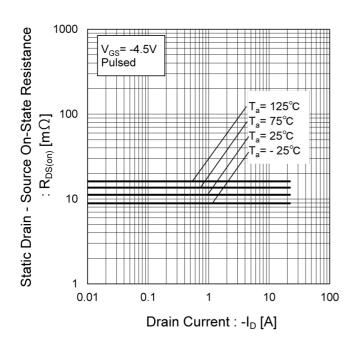


Fig.17 Typical Capacitances vs.

Drain - Source Voltage

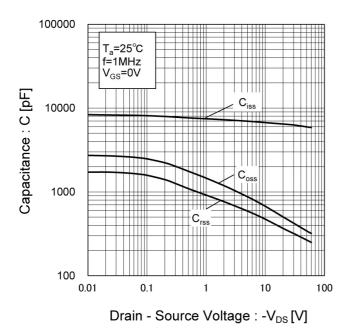


Fig.18 Switching Characteristics

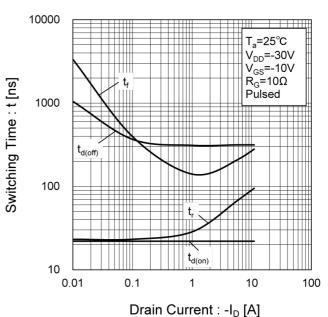


Fig.19 Typical Gate Charge

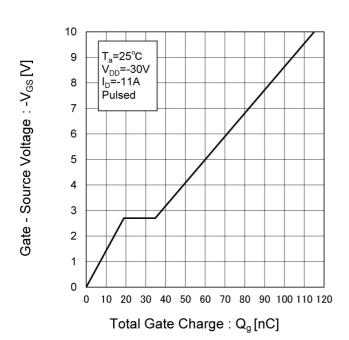
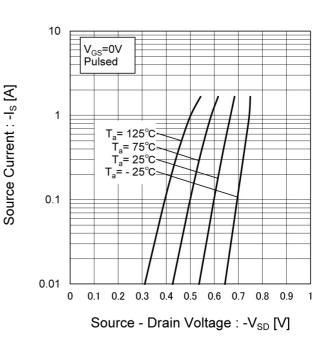


Fig.20 Source Current vs.

Source Drain Voltage



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

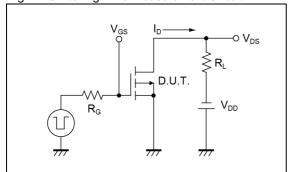


Fig.2-1 Gate Charge Measurement Circuit

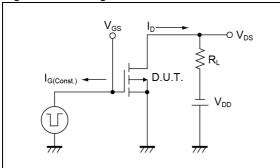


Fig.3-1 Avalanche Measurement Circuit

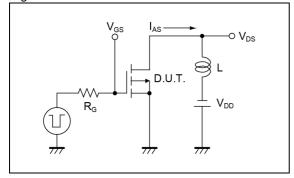


Fig.1-2 Switching Waveforms

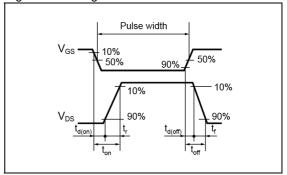


Fig.2-2 Gate Charge Waveform

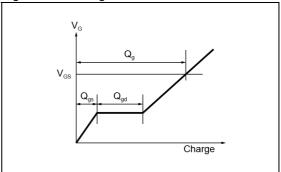
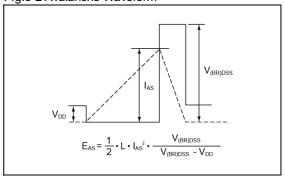
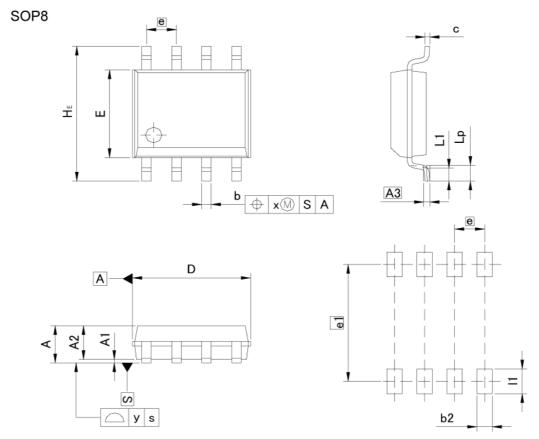


Fig.3-2 Avalanche Waveform



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES		
DIM	MIN	MAX	MIN	MAX		
Α	-	1.75	-	0.069		
A1	0.	15	0.0	006		
A2	1.40	1.60	0.055	0.063		
A3	0.5	25	0.0	10		
b	0.30	0.50	0.012	0.020		
С	0.10	0.30	0.004	0.012		
D	4.80	5.20	0.189	0.205		
Е	3.75	4.05	0.148	0.159		
е	1,3	27	0.0)50		
HE	5.70	6.30	0.224	0.248		
L1	0.40	0.60	0.016	0.024		
Lp	0.65	0.85	0.026	0.033		
х	0.	0.15		0.006		
У	0.10		0.004			
			0.0			
DIM	MILIM	ETERS	INC	HES		
DIM	MIN	MAX	MIN	MAX		

0.65

1.15

5.15

Dimension in mm/inches

b2

e 1 11 0.026

0.045

0.203

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1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JÁPAN	USA	EU	CHINA
CLASSⅢ	OL ACCIT	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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